

200mW SOD-323 SURFACE MOUNT Small Outline Flat Lead Plastic Package High Speed Switching Diode

Absolute Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter	Parameter Value		
PD	Power Dissipation	200	200 mW	
T _{STG}	Storage Temperature Range	-65 to +150	50 °C	
TJ	Operating Junction Temperature	+150	°C	
V _R	Reverse Voltage	80	V	
V _{RM}	Repetitive Peak Reverse Voltage	90	V	
I _{FM}	Forward Current	250	mA	
lo	Continuous Forward Current	150	mA	
I _{FRM}	Repetitive Peak Forward Current	500	mA	
I _{FSM}	Peak Forward Surge Current (Pulse Width=1us)	2	А	

These ratings are limiting values above which the serviceability of the diode may be impaired.

Specification Features:

- High Speed Switching Device (T_{RR} < 4.0 nS)</p>
- General Purpose Diodes
- Flat Lead SOD-323 Small Outline Plastic Package
- Surface Device Type Mounting
- RoHS Compliant
- Green EMC

Number: DB-010

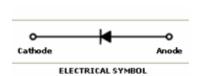
- Matte Tin(Sn) Lead Finish
- Band Indicates Cathode

Electrical Characteristics T_A = 25°C unless otherwise noted

Symbol	Parameter	Test Condition	Limits		Unit
Symbol			Min	Max	Unit
Bv	Breakdown Voltage	I _R =100μA	80		Volts
I _R	Reverse Leakage Current	V _R =80V		100	nA
VF	Forward Voltage	I _F =100mA		1.2	Volts
T _{RR}	Reverse Recovery Time	I _F =10mA			
		V _R =6V		4	nS
		R _L =100Ω			
С	Capacitance	$V_R=0.5V$, f=1 M_{HZ}		4	pF

Green Product

SOD-323 Flat Lead

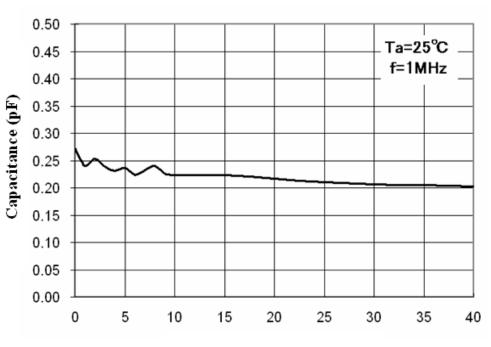


DEVICE MARKING CODE:

Device Type	Device Marking	
1SS355	S4	

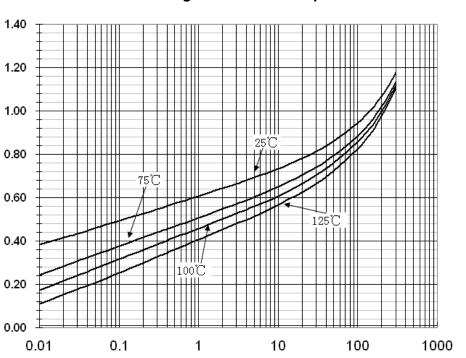


Typical Performance Characteristics



Total Capacitance

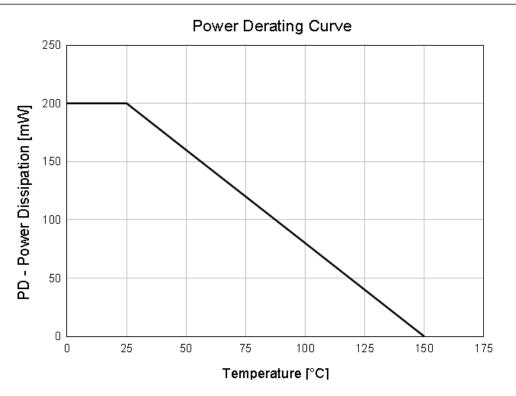
Reverse Voltage (V)



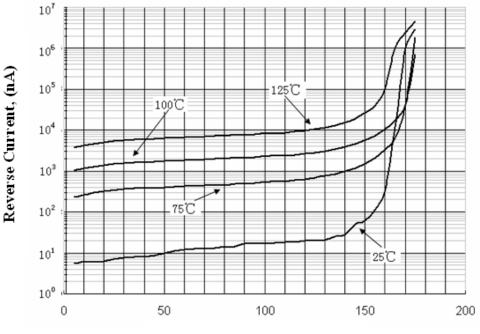
Forward Voltage vs Ambient Temperature

Number: DB-010 July 2011 Release, Revision F





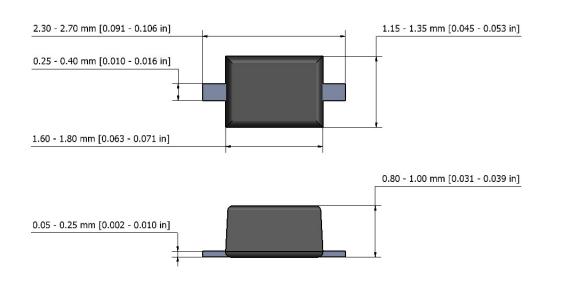




Reverse Voltage, VR (V)



SOD-323 Package Outline



NOTES:

The above package outline is similar to JEITA SC-90.
Dimensions are exclusive of Burrs, Mold Flash & Tie Bar extrusions.



NOTICE

The information presented in this document is for reference only. Tak Cheong reserves the right to make changes without notice for the specification of the products displayed herein.

The product listed herein is designed to be used with ordinary electronic equipment or devices, and not designed to be used with equipment or devices which require high level of reliability and the malfunction of with would directly endanger human life (such as medical instruments, transportation equipment, aerospace machinery, nuclear-reactor controllers, fuel controllers and other safety devices), Tak Cheong Semiconductor Co., Ltd., or anyone on its behalf, assumes no responsibility or liability for any damagers resulting from such improper use of sale.

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